5176264-6 - ACTIVE

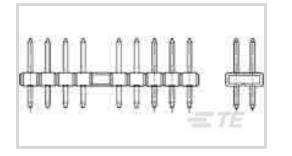
AMPMODU | AMPMODU 2 mm

TE Internal #: 5176264-6 PCB Mount Header, Vertical, Board-to-Board, 14 Position, 2 mm [. 079 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU 2 mm

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **14**

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Unshrouded

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	No
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	14
Number of Rows	2
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	650 VAC
Operating Voltage	200 VAC
Body Features	
Primary Product Color	Black
Contact Features	

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PCB Mount Header, Vertical, Board-to-Board, 14 Position, 2 mm [.079 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU 2 mm



Contact Mating Area Length	4 mm[.158 in]
Mating Square Post Dimension	.5 mm[.02 in]
	78.74 µin
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.203 μm[8 μin]
Contact Type	Pin
Contact Current Rating (Max)	1 A
Termination Features	
Round Termination Post & Tail Diameter	.6 mm[.024 in]
Termination Post & Tail Length	2.6 mm[.102 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2 mm[.079 in]
Housing Material	Thermoplastic
Dimensions	
Connector Height	1.75 mm[44.45 in]
Row-to-Row Spacing	2 mm[.079 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Operating Temperature Range	-40 – 105 °C[-40 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	

PCB Mount Header, Vertical, Board-to-Board, 14 Position, 2 mm [.079 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU 2 mm



Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	1000
Packaging Type	Box
Other	
Position Locations Omitted	0
Product Compliance	
Product Compliance For compliance documentation, visit the product page on TE.com>	
For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant
For compliance documentation, visit the product page on TE.com>	Compliant Compliant
For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	
For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU EU ELV Directive 2000/53/EC	Compliant

ppm.

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

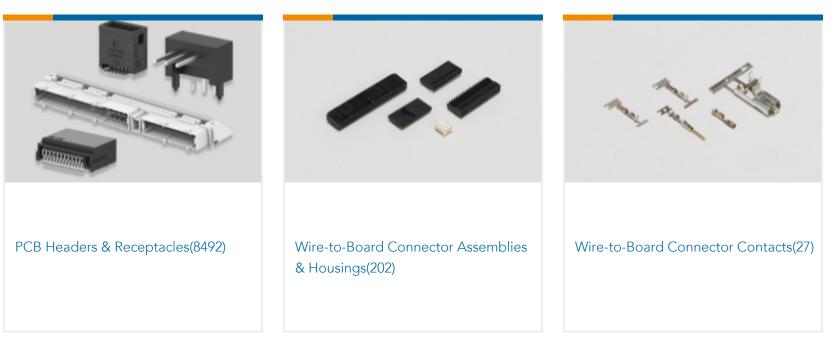
Compatible Parts

PCB Mount Header, Vertical, Board-to-Board, 14 Position, 2 mm [.079 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU 2 mm

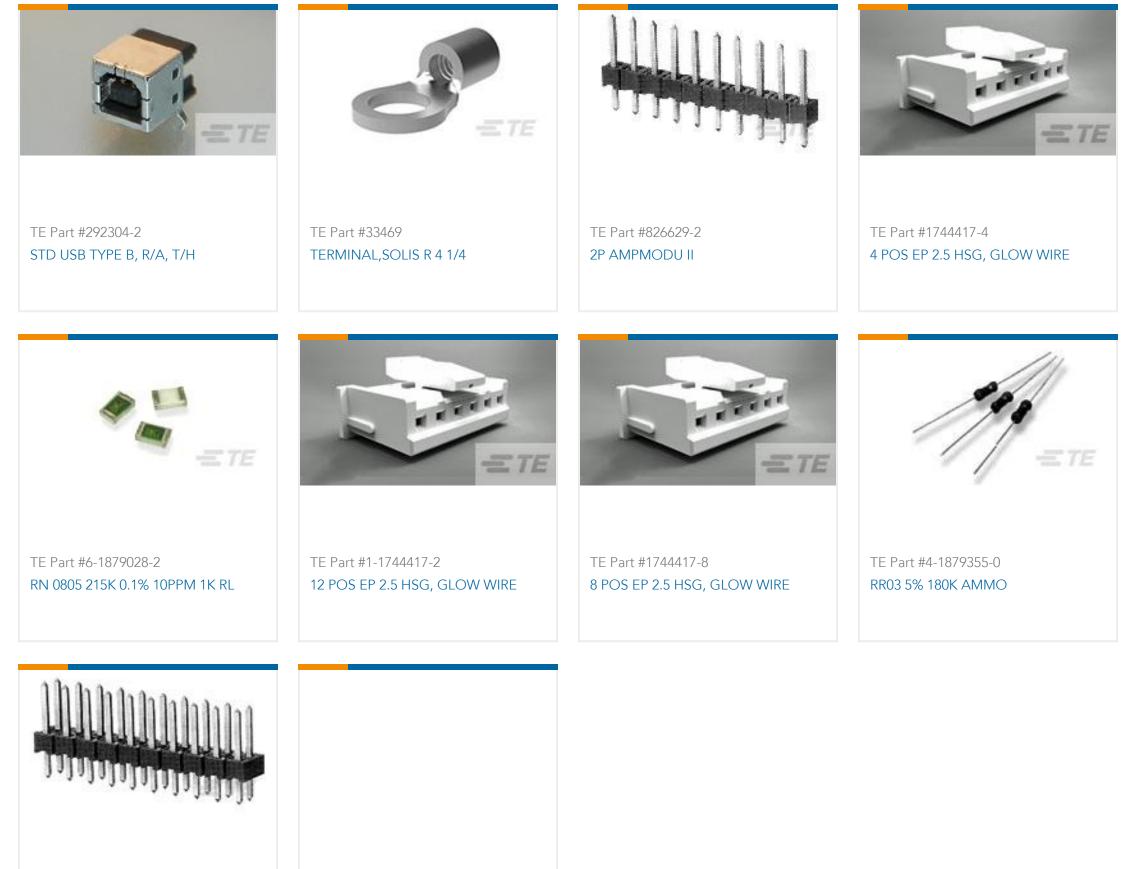


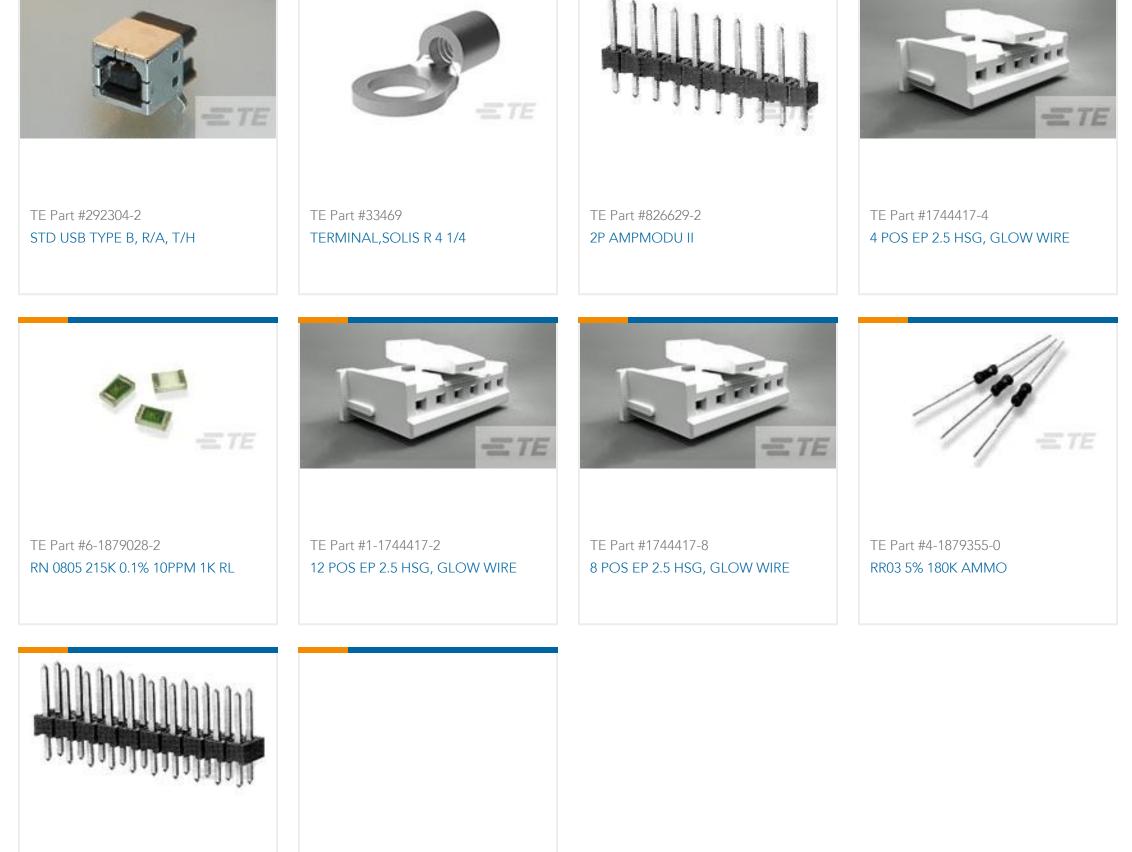


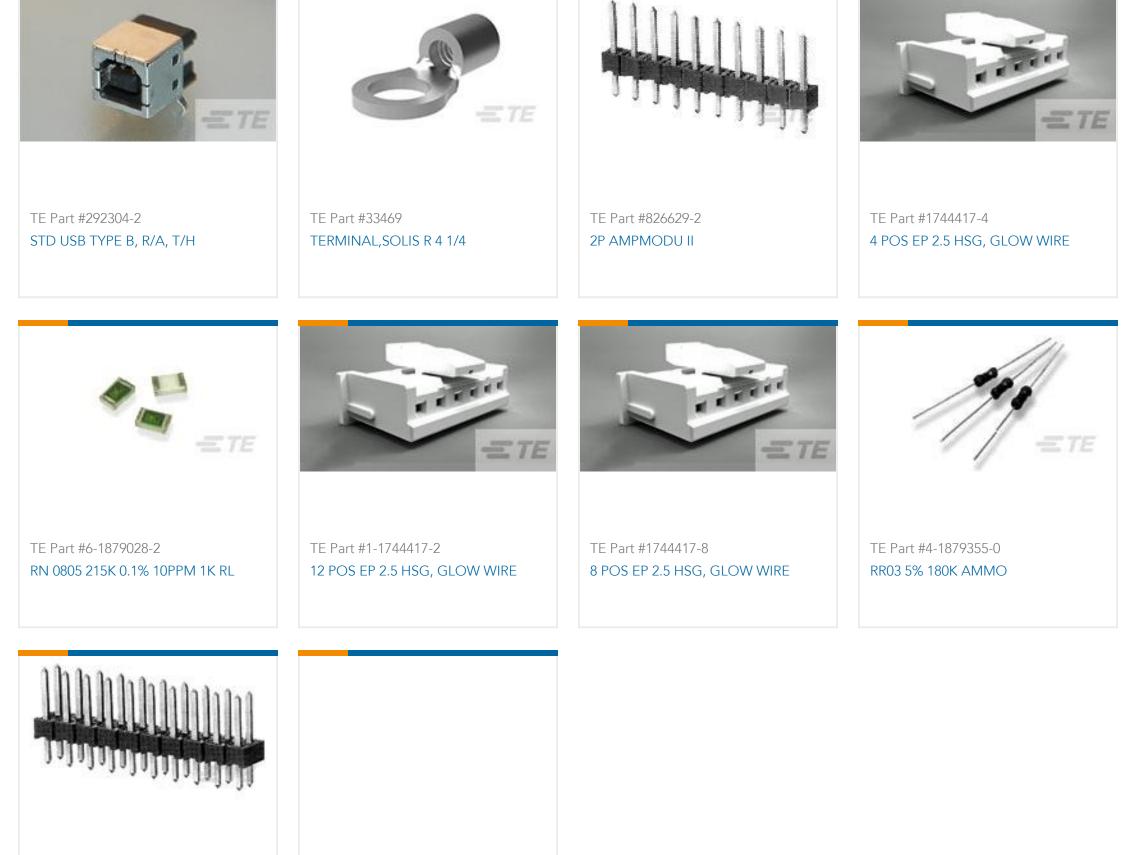
Also in the Series AMPMODU 2 mm



Customers Also Bought







TE Part #6-146254-0 20 MODII HDR DRST B/A .100CL

TE Part #2085462-1 CONN,SKT,STR,SLDR,FLATPAQ

PCB Mount Header, Vertical, Board-to-Board, 14 Position, 2 mm [.079 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU 2 mm



Documents

Product Drawings AMPMODU 2MM V 14P AU:0.2 BLACK LF

English

CAD Files

Customer View Model ENG_CVM_5176264-6_O1.3d_igs.zip

English

Customer View Model

ENG_CVM_5176264-6_O1.3d_stp.zip

English

Customer View Model

ENG_CVM_5176264-6_O1.2d_dxf.zip

English

3D PDF

English

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Datasheets & Catalog Pages AMPMODU_INTERCONNECTION_SYSTEM_SECTION3AND4

English